



Terminals & Splices > PCB Terminals



PCB Terminal Type: **Receptacle**

PCB Hole Diameter: **3.18 mm [ .125 in ]**

Mating Pin Diameter: **1.47 mm [ .058 in ]**

Compatible Insulation Diameter (Max): **1.65 mm [ .065 in ]**

Compatible Insulation Diameter Range: **.89 – 1.65 mm [ .035 – .065 in ]**

## Features

### Product Type Features

Terminal Features	Stud Hole
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### Contact Features

PCB Terminal Type	Receptacle
Mating Pin Diameter	1.47 mm[.058 in]
Terminal Plating Material	Tin
Terminal Orientation	Straight

### Termination Features

Termination Method to PCB	Through Hole - Solder
Product Terminates To	Wire & Cable

### Mechanical Attachment

Wire Insulation Support	With
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### Dimensions

Terminal Material Thickness	.25 mm[.01 in]
PCB Hole Diameter	3.18 mm[.125 in]
Compatible Insulation Diameter (Max)	1.65 mm[.065 in]

Compatible Insulation Diameter Range	.89 – 1.65 mm [.035 – .065 in]
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Wire Size	.12 – .4 mm <sup>2</sup>
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### Usage Conditions

Insulation Option	Uninsulated
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### Packaging Features

Packaging Quantity	15000
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Packaging Method	Box
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### Product Compliance

[For compliance documentation, visit the product page on TE.com>](#)

EU RoHS Directive 2011/65/EU	Compliant
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EU ELV Directive 2000/53/EC	Compliant
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China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
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EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2025 (250) Candidate List Declared Against: JAN 2023 (233) Does not contain REACH SVHC
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Halogen Content	Low Halogen - Br, Cl, F < 900 ppm per homogenous material. Also BFR/CFR/PVC Free
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Solder Process Capability	Not applicable for solder process capability
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#### Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: <https://echa.europa.eu/guidance-documents/guidance-on-reach>

### Customers Also Bought



## Documents

### Product Drawings

058 PIN REC 26-22 .010TPBECU

English

### CAD Files

3D PDF

3D

Customer View Model

[ENG\\_CVM\\_CVM\\_60888-3\\_AJ\\_c-60888-3-aj.2d\\_dxf.zip](#)

English

Customer View Model

[ENG\\_CVM\\_CVM\\_60888-3\\_AJ\\_c-60888-3-aj.3d\\_igs.zip](#)

English

Customer View Model

[ENG\\_CVM\\_CVM\\_60888-3\\_AJ\\_c-60888-3-aj.3d\\_stp.zip](#)

English

By downloading the CAD file I accept and agree to the [Terms and Conditions](#) of use.

### Datasheets & Catalog Pages

PRINTED CIRCUIT BOARD TERMINALS AND DISCONNECTS

English

### Product Specifications

Application Specification

English